Power MOSFET

20 V, 3.2 A, Single N-Channel, SOT-23

Features

- Leading Planar Technology for Low Gate Charge / Fast Switching
- 2.5 V Rated for Low Voltage Gate Drive
- SOT-23 Surface Mount for Small Footprint
- NVR Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

Applications

- Load/Power Switch for Portables
- Load/Power Switch for Computing
- DC–DC Conversion

MAXIMUM RATINGS (T_J= 25°C unless otherwise stated)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	20	V
Gate-to-Source Voltage			V _{GS}	±12	V
Continuous Drain Steady		$T_A = 25^{\circ}C$	I _D	3.2	А
Current (Note 1)	State	$T_A = 85^{\circ}C$		2.4	А
Steady State Power Dissipation (Note 1)	Stea	dy State	PD	1.25	W
Pulsed Drain Current	t _p =	= 10 μs	I _{DM}	10.0	А
Operating Junction and Storage Temperature			T _J , T _{stg}	–55 to 150	°C
Continuous Source Current (Body Diode)			I _S	1.6	А
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Мах	Unit
Junction-to-Ambient (Note 1)	R_{\thetaJA}	100	°C/W
Junction-to-Ambient (Note 2)	R_{\thetaJA}	300	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. Surface-mounted on FR4 board using 1 in sq pad size
- (Cu area = 1.127 in sq [1 oz] including traces).
- 2. Surface-mounted on FR4 board using the minimum recommended pad size.

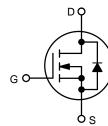


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V _{(BR)DSS}	R _{DS(on)} Typ	I _D Max (Note 1)	
20 V	70 mΩ @ 4.5 V	3.6 A	
	88 mΩ @ 2.5 V	3.1 A	





Gate

Source



- VR1 = Device Code for NVR4501N
- M = Date Code*

STYLE 21

= Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation and/or overbar may vary depending upon manufacturing location.

ORDERING INFORMATION

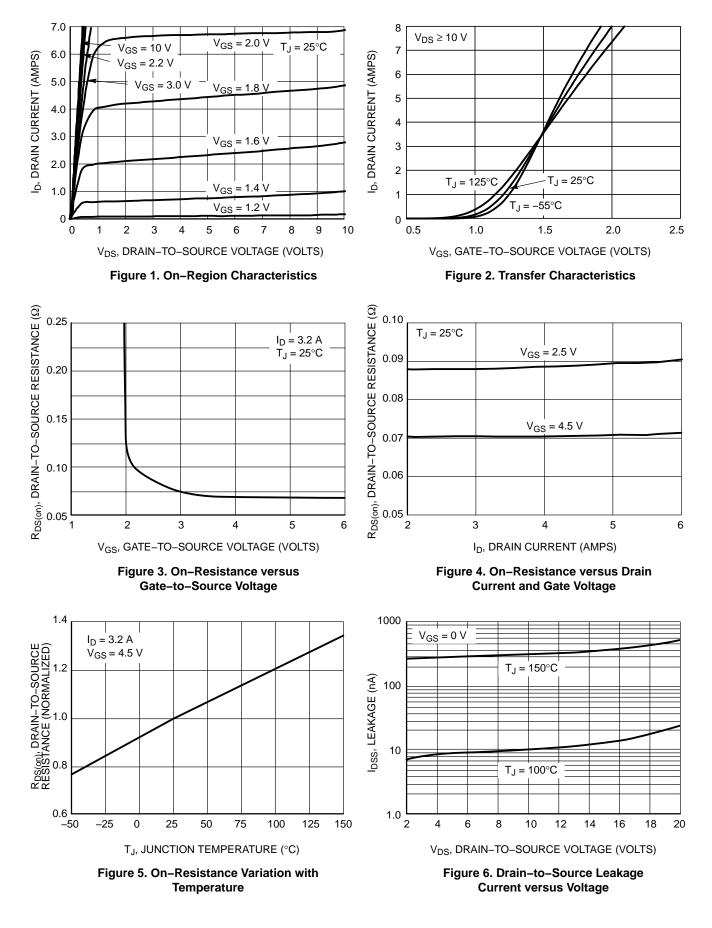
Device	Package	Shipping†
NTR4501NT1G	SOT-23 (Pb-Free)	3000 / Tape & Reel
NVR4501NT1G	SOT-23 (Pb-Free)	3000 / Tape & Reel

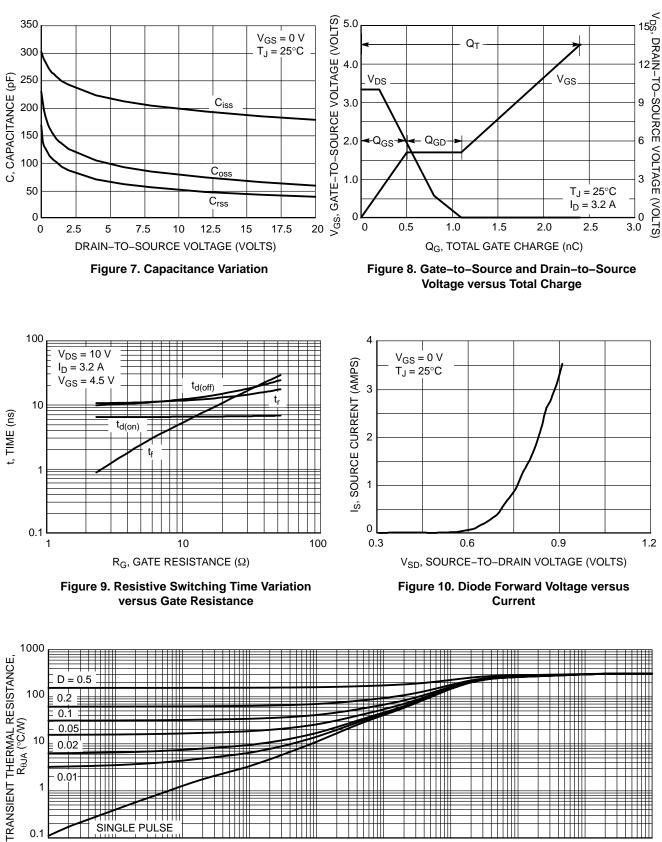
⁺For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

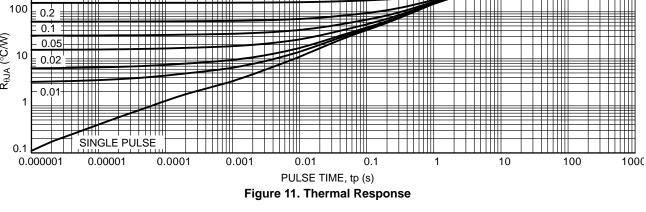
Electrical Characteristics ($T_J = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Units
OFF CHARACTERISTICS	-				-	-	-
Drain-to-Source Breakdown Voltage (Note 3)	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$		20	24.5		V
Drain-to-Source Breakdown Voltage Temperature Coefficient	$V_{(BR)DSS}/T_J$				22		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V$	$T_J = 25^{\circ}C$			1.5	μΑ
		V _{DS} = 16 V	$T_J = 85^{\circ}C$			10	μΑ
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 12 V$				±100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage (Note 3)	V _{GS(TH)}	$V_{GS} = V_{DS}, I_{DS}$	_D = 250 μA	0.65		1.2	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-2.3		mV/°C
Drain-to-Source On Resistance	_	V _{GS} = 4.5 V, I _D = 3.6 A			70	80	
	R _{DS(on)}	V _{GS} = 2.5 V,	I _D = 3.1 A		88	105	mΩ
Forward Transconductance	9fs	V _{DS} = 5.0 V, I _D = 3.6 A			9		S
CHARGES AND CAPACITANCES							
Input Capacitance	C _{iss}	V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = 10 V			200		pF
Output Capacitance	C _{oss}				80		
Reverse Transfer Capacitance	C _{rss}				50		
Total Gate Charge	Q _{G(TOT)}	$V_{GS} = 4.5 \text{ V}, V_{DS} = 10 \text{ V},$ $I_D = 3.6 \text{ A}$			2.4	6.0	nC
Gate-to-Source Gate Charge	Q _{GS}				0.5		
Gate-to-Drain Charge	Q _{GD}				0.6		
SWITCHING CHARACTERISTICS (Note 4)							
Turn–On Delay Time	t _{d(on)}				6.5	13	ns
Rise Time	t _r	V _{GS} = 4.5 V, \	/ps = 10 V.		12	24	
Turn–Off Delay Time	t _{d(off)}	I _D = 3.6 A, R	$G = 6.0 \Omega$		12	24	
Fall Time	t _f				3	6	1
SOURCE-DRAIN DIODE CHARACTERISTICS	6						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _{SD} = 1.6 A			0.8	1.2	V
Reverse Recovery Time	t _{RR}	$V_{GS} = 0 V,$ $d_{IS}/d_t = 100 A/\mu s,$ $I_S = 1.6 A$			7.1		1
Charge Time	t _a				5		ns
Discharge Time	t _b				1.9	1	1
Reverse Recovery Charge	Q _{RR}				3.0		nC

Pulse Test: Pulse width ≤ 300 μs, duty cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.



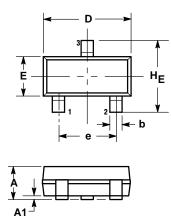


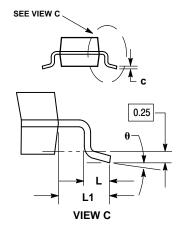


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PACKAGE DIMENSIONS

SOT-23 (TO-236) CASE 318-08 ISSUE AP





NOTES:

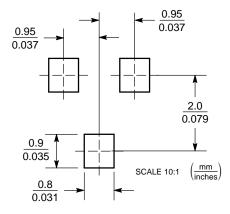
- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH. 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
- DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.89	1.00	1.11	0.035	0.040	0.044	
A1	0.01	0.06	0.10	0.001	0.002	0.004	
b	0.37	0.44	0.50	0.015	0.018	0.020	
С	0.09	0.13	0.18	0.003	0.005	0.007	
D	2.80	2.90	3.04	0.110	0.114	0.120	
E	1.20	1.30	1.40	0.047	0.051	0.055	
е	1.78	1.90	2.04	0.070	0.075	0.081	
L	0.10	0.20	0.30	0.004	0.008	0.012	
L1	0.35	0.54	0.69	0.014	0.021	0.029	
HE	2.10	2.40	2.64	0.083	0.094	0.104	
θ	0°		10°	0°		10°	

PIN 1. GATE 2. SOURCE 3. DRAIN

STYLE 21:

SOLDERING FOOTPRINT



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

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